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Application ID: 10665651 \*10665651\*

Title of Invention: THIN AND HEAT RADIANT  
SEMICONDUCTOR PACKAGE AND  
METHOD FOR MANUFACTURING

First Named Inventor: Jae Ku

Domestic/Foreign Application: Domestic Application

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<b>Title of Invention</b>	<b>THIN AND HEAT RADIANT SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING</b>						
<p>Application Number: 10/665651 *10/665651*</p> <p>Date: 2003-09-19</p> <p>First Named Applicant: Jae Hun Ku</p> <p>Confirmation Number: 6079</p> <p>Attorney Docket Number: AMKOR041G</p>							
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<b>Documents being submitted</b> us-ids	<b>Files</b> ids5-usidst.xml us-ids.dtd us-ids.xsl
<b>Comments</b>	

<b>ELECTRONIC INFORMATION DISCLOSURE STATEMENT</b>
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	48	6380048	2002-04-30	BOON ET AL.
	49	6384472	2002-05-07	HUANG
	50	6388336	2002-05-14	VENKATESHWARAN ET AL.

**Signature**

<b>Examiner Name</b>	<b>Date</b>